

UPDATE

New Equipment Installation

June 2014

Netvia Group is pleased to announce the addition of our new wet planarizer from Pola Massa, which will complement and improve our existing dry planarization. This new line will enable us to automate our planarization of printed circuit boards where non-conductive and conductive via fill are required.

As filled vias and via in pad (VIP) are required on approximately 40% of the PCB's we produce, it is necessary for us to have an efficient, automated and effective process in place to produce consistent results.

The line was customized to include high pressure rinse and a filtration unit used to reclaim Copper which reduces waste treatment.

Should you have any questions about how we can help you with filled vias, do not hesitate to let us know.

"We are excited at the opportunity to continuously improve our process and keep our focus on the highest quality as a way of giving back to our customers that have entrusted us with their PCB fabrication..."

- Jeff Forbus, President



Pola Massa PEM 650

Features

- In-line and automated planarization of PCB's
- Automatic height adjustment of the ten orbital brushes
- Wet sanding to create a flush surface
- High pressure rinsing
- Dryer
- Copper filtration / reclaim